



PRODUCT SPECIFICATION

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1.SCOPE:

This specification covers the requirements for product performance of 3.00mm pitch wire to wire or wire to board connector series.

2.PART NAME & PART NUMBERS

Part Name		Part Number
Housing		C3030HF/HFA/HFB/HFC.. C3030HM/HMA/HMB/HMC..
Terminal	F-T	C3030F-T C3030F-T-A C3030F-T-B/C C3030F-T-D-H
	M-T	C3030M-T C3030M-T-A
Wafer		C3030WV/WVA/WVB/WVC/WVD/WVE/WVF/WVG...
		C3030WR/WRA/WRB/WRC/WRD/WRE/WRG...

3. CONSTRUCTION. DIMENSIONS . MATERIAL & SURFACE FINISH

Construction and dimensions shall be in accordance with the referenced drawings.

Material and surface finish shall be as specified below.

Part Name		Material	Surface finish
Housing		Nylon 66	UL94V-0
Terminal	F-T	Phosphor Bronze	Tin over Nickel/Gold over Nickel
		High conductive copper alloy	Tin over Nickel/Gold over Nickel
	M-T	Phosphor Bronze	Tin over Nickel/Gold over Nickel
		High conductive copper alloy	Tin over Nickel/Gold over Nickel
Wafer	Body	Nylon 66/9T/LCP	UL94V-0
	Pin	Brass/Phosphor Bronze	Tin over Nickel/Gold over Nickel
		High conductive copper alloy	Tin over Nickel/Gold over Nickel

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4. RATINGS & APPLICABLE WIRES

MAXIMUM CURRENT RATING (Amperes)
WIRE-TO-WIRE&WIRE-TO-BOARD
(Brass & Phosphor Bronze)

Dual Row								
Wire Size \ Circuits	2-Circuit		6-Circuit		12-Circuit		24-Circuit	
	W-W	W-B	W-W	W-B	W-W	W-B	W-W	W-B
	Amps	Amps	Amps	Amps	Amps	Amps	Amps	Amps
AWG#18	7.0	8.5	6.0	6.4	5.5	5.5	5.0	5.0
AWG#20	6.0	7.0	5.0	5.5	4.5	5.0	4.0	4.5
AWG#22	5.5	6.0	4.0	4.5	3.5	4.5	3.0	3.5
AWG#24	4.5	5.0	4.0	4.5	3.0	3.5	2.0	3.0
AWG#26	4.0	4.5	3.0	4.0	2.5	3.3	1.5	2.5
AWG#28	3.0	4.0	2.0	3.0	2.0	2.5	1.0	2.0
AWG#30	3.0	3.5	2.0	3.0	2.0	1.7	1.0	1.0

Single Row						
Wire Size \ Circuits	2-Circuit		6-Circuit		12-Circuit	
	W-W	W-B	W-W	W-B	W-W	W-B
	Amps	Amps	Amps	Amps	Amps	Amps
AWG#18	7.0	8.5	6.5	7.0	6.5	6.5
AWG#20	6.5	7.0	5.0	5.5	4.5	5.0
AWG#22	5.5	6.0	4.0	4.5	3.5	4.0
AWG#24	5.0	5.5	4.0	4.5	3.0	3.5
AWG#26	4.0	4.5	3.0	4.0	2.5	3.5
AWG#28	3.0	4.0	2.0	3.0	2.0	3.0
AWG#30	3.0	3.5	2.0	3.0	2.0	2.5

MAXIMUM CURRENT RATING (Amperes)
WIRE-TO-BOARD
(High conductive copper alloy)

Wire Size \ Circuits	2 Pins	4 Pins	6-8 Pins	10 Pins	12 Pins	14-18 Pins	20-24 Pins
	W-B	W-B	W-B	W-B	W-B	W-B	W-B
	Amps	Amps	Amps	Amps	Amps	Amps	Amps
AWG#16	12.0	11.5	9.0	9.0	7.5	7.0	6.5
AWG#18	11.0	10.0	8.0	8.0	6.5	6.0	5.5
AWG#20	10.0	9.0	7.5	6.5	6.0	5.5	5.0

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5. CONDITIONS:

Number	Item	Requirement
①	Bend up	4°Max.
	Bend down	4°Max.
	Twisting	3°Max.
	Rolling	8°Max.
②	Bell mouth (flare)	0.2-0.5 mm
③	Cut-off tab length	0.2 mm Max.
④	Extruded wire length	0-1.0 mm
⑤	Seam	Seam shall not be opened and no wire
⑥	Wire strip length	1.2-1.7 mm ref.
⑦	Lance height	0.3 mm ref.

After crimping, the crimped areas [⑤、⑥] should be as follows.

Wire Size (AWG)	Terminal Part Number	Conductor(mm)		Insulation(mm)		Crimp Strength (Kgf)
		Crimp Width	Crimp Height	Crimp Width	Crimp Height	
#16	C3030F-T C3030M-T C3030F-T-A C3030M-T-A C3030F-T-A-H/L C3030M-T-A-L C3030F-T-C/B C3030F-T-C/B-L C3030F-T-D-H	1.65±0.15	1.50-1.65	2.40 (Max) 1.85 (Max)	2.30(Max)	6.43(Min.)
#18			1.30-1.45		1.95(Max)	6.43(Min.)
#20		1.55±0.15	1.20~1.30		1.85(Max)	5.90(Min.)
#22			1.10~1.20		1.75(Max)	3.60(Min.)
#24			1.00~1.10		1.65(Max)	2.27(Min.)
#26			0.90~1.00		1.55(Max)	1.36(Min.)
#28			0.80~0.90		1.45(Max)	0.90(Min.)
#30			0.70~0.80		1.35(Max)	0.67(Min.)

Note: no distorted after terminal crimped.

6. PERFORMANCE
6.1 ELECTRICAL PERFORMANCE

Test Description		Procedure	Requirement
6-1-1	Contact Resistance	Mate connectors, measure by dry circuit, 20mV Max. 10mA. (Based upon JIS C5402 5.4)	10mΩ Max.
6-1-2	Insulation Resistance	Mate connectors, apply 500V DC between adjacent terminal or ground. (Based upon JIS C5402 5.2/MIL-STD-202 Method 302 Cond. B)	1000MΩ Min.
6-1-3	Dielectric Withstanding Voltage	Mate connectors, apply 1500V AC (rms) for 1 minute between adjacent terminal or ground. (Based upon JIS C5402 5.1/MIL-STD-202 Method 302 Cond. B)	No Breakdown
6-1-4	Contact Resistance on Crimped Portion	Crimp the applicable wire on to the terminal, measure by dry circuit, 20mV Max., 10mA.	5mΩ Max.

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6.2 MECHANICAL PERFORMANCE

Test Description		Procedure		Requirement
6-2-1	Insertion & Withdrawal Force	Insert and withdraw connectors at the speed rate of 25 ± 3 mm/minute.		Used with C3030F-T-A/B terminal: 0.82kgf per circuit Max. mate force & 0.24kgf per circuit Min. unmate force Used with C3030F-T-C terminal: 0.41kgf per circuit Max. mate force & 0.20kgf per circuit Max. unmate force
6-2-2	Crimping Pull Out Force	Fix the crimped terminal, apply axial pull out force on the wire at the speed rate of 25 ± 3 mm/minute. (Based upon JIS C5402 6.8)	AWG #16	6.43kgf Min.
			AWG #18	6.43kgf Min.
			AWG #20	5.9kgf Min.
			AWG #22	3.9kgf Min.
			AWG #24	2.9kgf Min.
			AWG #26	1.9kgf Min.
			AWG #28	1.0kgf Min.
			AWG #30	0.7kgf Min.
6-2-3	Terminal Insertion Force	Insert the crimped terminal into the housing at a constant speed of 25 ± 3 mm per minute.		1.5kgf Max.
6-2-4	Terminal/Housing Retention Force	Apply axial pull out force at the speed rate of 25 ± 3 mm/minute on the terminal assembled in the		2.5kgf Min.
6-2-5	Post Retention Force	Apply axial push force at the speed rate of 25 ± 3 mm/minute.		1.5kgf Min.
6-2-6	Durability	When mated up to 30 cycles repeatedly	Contact Resistance	20mΩ Max.
6-2-7	Vibration	Amplitude: 1.52mm P-P Sweep time: 10-55-10 Hz/min Duration: 2 hours in each X.Y.Z. axes (Based upon MIL-STD-202 Method 201A)	Appearance	No Damage
			Contact Resistance	20mΩ Max.
			Discontinuity	1μsec. Max.
6-2-8	Physical Shock	490m/s ² {50G}, 3 strokes in each X.Y.Z. axes. (Based upon JIS C0041/MIL-STD-202 Method 213B Cond. A)	Appearance	No Damage
			Contact Resistance	20mΩ Max.
			Discontinuity	1μsec. Max.

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6.3 ENVIRONMENTAL PERFORMANCE AND OTHERS

Test Description		Procedure		Requirement
6-3-1	Temperature Rise	Carrying rated current load. (Based upon UL 498)	Temperature Rise	30°C Max.
6-3-2	Heat Resistance	105 ± 2°C, 96 hours (Based upon JIS C0021/MIL-STD-202 Method 108A Cond. A)	Appearance	No Damage
			Contact Resistance	20mΩ Max.
6-3-3	Cold Resistance	-40 ± 3°C, 96 hours (Based upon JIS C0020)	Appearance	No Damage
			Contact Resistance	20mΩ Max.
6-3-4	Humidity	Temperature: 40 ± 2°C Relative Humidity: 90 ~ 95% Duration: 96 hours (Based upon JIS C0022/MIL-STD-202 Method 103B Cond. B)	Appearance	No Damage
			Contact Resistance	20mΩ Max.
			Insulation Resistance	100MΩ Min.
			Dielectric Withstandin	Must meet 6-1-3
6-3-5	Temperature Cycling	5 cycles of: a) - 55°C 30 minutes b) +85°C 30 minutes (Based upon JIS C0025)	Appearance	No Damage
			Contact Resistance	20mΩ Max.
6-3-6	Salt Spray	24 hours exposure to a salt spray from the 5 % solution at 35 ± 2°C. (Based upon JIS C0023/MIL-STD-202 Method 101D Cond. B)	Appearance	No Damage
			Contact Resistance	20mΩ Max.
6-3-7	SO ₂ Gas	24 hours exposure to 50 ± 5ppm. SO ₂ gas at 40 ± 2°C.	Appearance	No Damage
			Contact Resistance	20mΩ Max.
6-3-8	NH ₃ Gas	40 minutes exposure to NH ₃ gas evaporating from 28% Ammonia solution.	Appearance	No Damage
			Contact Resistance	20mΩ Max.
6-3-9	Solderability	Soldering Time: 3~5 sec. Solder Temperature: 240 ± 5°C	Solder Wetting	Solder coverage: 95% Min.
6-3-10	Resistance to Soldering Heat	<u>Normal materials</u> Soldering Time: 3~5 sec. Solder Temperature: 250 ± 5°C <u>High temperature resistant materials</u> Soldering Time: 3~5 sec. Solder Temperature: 260 ± 5°C	Appearance	No Damage